

# Product Change Notification / SYST-01QYUU959

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02-Jun-2022

# **Product Category:**

8-bit Microcontrollers

# **PCN Type:**

**Document Change** 

# **Notification Subject:**

ERRATA - PIC16(L)F19195/6/7 Family Silicon Errata and Data Sheet Clarification Errata Document Revision

# **Affected CPNs:**

SYST-01QYUU959\_Affected\_CPN\_06022022.pdf SYST-01QYUU959\_Affected\_CPN\_06022022.csv

# **Notification Text:**

SYST-01QYUU959

Microchip has released a new Errata for the PIC16(L)F19195/6/7 Family Silicon Errata and Data Sheet Clarification of devices. If you are using one of these devices please read the document located at PIC16(L)F19195/6/7 Family Silicon Errata and Data Sheet Clarification.

**Notification Status: Final** 

#### **Description of Change:**

- 1) Added Data Sheet Clarification 1 (I/O Ports) for data sheet revision E.
- 2) Included Register 14-5, Table 14-2, Table 4-12, and Table 38-1 with pin RA5 removed in reference to WPUA5.

Impacts to Data Sheet: None

Reason for Change: To Improve Productivity

**Change Implementation Status: Complete** 

**Date Document Changes Effective:** 02 June 2022

NOTE: Please be advised that this is a change to the document only the product has not been changed.  Markings to Distinguish Revised from Unrevised Devices: N/A
Attachments:
PIC16(L)F19195/6/7 Family Silicon Errata and Data Sheet Clarification
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# Affected Catalog Part Numbers(CPN)

PIC16F19197-E/5LXVAO

PIC16LF19196-E/5LXVAO

PIC16F19195-E/MR

PIC16F19196-E/MR

PIC16F19197-E/MR

PIC16LF19195-E/MR

PIC16LF19196-E/MR

PIC16LF19197-E/MR

PIC16F19195-E/PT

PIC16F19196-E/PT

PIC16F19197-E/PT

PIC16LF19195-E/PT

PIC16LF19196-E/PT

PIC16LF19197-E/PT

PIC16F19197-E/PTVAO

PIC16F19197-I/5LXVAO

PIC16F19195-I/MR

PIC16F19196-I/MR

PIC16F19197-I/MR

PIC16LF19195-I/MR

PIC16LF19196-I/MR

PIC16LF19197-I/MR

PIC16LF19197-I/PTC03

PIC16F19195-I/PT

PIC16F19196-I/PT

PIC16F19197-I/PT

PIC16LF19195-I/PT

PIC16LF19196-I/PT

PIC16LF19197-I/PT

PIC16F19197T-I/5LXVAO

PIC16LF19195T-I/MR

PIC16LF19196T-I/MR

PIC16LF19197T-I/MR

PIC16LF19197T-I/PTC04

PIC16LF19197T-I/PTC05

PIC16F19195T-I/PT

PIC16F19196T-I/PT

PIC16F19197T-I/PT

PIC16LF19195T-I/PT

PIC16LF19196T-I/PT

PIC16LF19197T-I/PT

PIC16LF19196T-E/5LXVAO

PIC16LF19196T-E/MRVAO PIC16F19197T-E/PT PIC16LF19197T-E/PT PIC16LF19197T-E/PTVAO cument Revision



# PIC16(L)F19195/6/7

# PIC16(L)F19195/6/7 Family Silicon Errata and Data Sheet Clarification

The PIC16(L)F19195/6/7 family devices that you have received conform functionally to the current Device Data Sheet (DS40001873**E**), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in Table 1. The silicon issues are summarized in Table 2.

The errata described in this document will be addressed in future revisions of the PIC16(L)F19195/6/7 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of Table 2 apply to the current silicon revision (A4).

Data Sheet clarifications and corrections start on page 8, following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB<sup>®</sup> IDE and Microchip's programmers, debuggers, and emulation tools, which are available at the Microchip corporate website (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

- Using the appropriate interface, connect the device to the hardware debugger.
- 2. Open an MPLAB IDE project.
- 3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
- For MPLAB X IDE, select <u>Window > Dashboard</u> and click the **Refresh Debug Tool Status** icon
- 5. Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

**Note:** If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various PIC16(L)F19195/6/7 silicon revisions are shown in Table 1.

TABLE 1: SILICON DEVREV VALUES

Part Number	Device ID <sup>(1)</sup>		Revision ID for Silicon Revision <sup>(2)</sup>		
		A1	А3	A4	
PIC16F19195	3084h	2001h	2003h	2004h	
PIC16LF19195	3086h	2001h	2003h	2004h	
PIC16F19196	3085h	2001h	2003h	2004h	
PIC16LF19196	3087h	2001h	2003h	2004h	
PIC16F19197	30A2h	2001h	2003h	2004h	
PIC16LF19197	30A3h	2001h	2003h	2004h	

- **Note 1:** The Device and Revision IDs is located at the respective addresses 8006h and 8005h of configuration memory space.
  - 2: Refer to the "PIC16(L)F1919X Memory Programming Specification" (DS40001846) for detailed information on Device and Revision IDs for your specific device.

TABLE 2: SILICON ISSUE SUMMARY

Module	Feature	Item Number	Summary		ffecte	
		Number	-	<b>A</b> 1	А3	<b>A4</b>
	ADC <sup>2</sup> Clock Selection	1.1	Static MSB with FRC selected as ADC clock source.	Х		
	ADC <sup>2</sup> with Fixed Voltage Reference (FVR)	1.2	Using the FVR as the ADC positive voltage reference can cause missing codes.	Х		
Analog-to-Digital Converter with	ADC <sup>2</sup> FRC Clock Sleep Mode	1.3	If in Sleep and ADRC is used, the oscillator continues to run after conversion.	Х		
Computation (ADC <sup>2</sup> )	ADC <sup>2</sup> FRC Clock ADGO Delay	1.4	When using FRC as clock source, there is a delay of 1 instruction cycle.	Х		
	Switching 1.5 gate		When switching to FVR, some PMOS gates turn on and feed current back into the networks.	Х		
	ADC <sup>2</sup> Conversion 1.6		At the very beginning of the ADC conversion, the input signal may briefly be pulled to ground.			
Reset and VBAT	VBAT with ULPBOR	2.1	Higher current with ULPBOR active.	Х		
	LP Ladder	3.1	Resistance of LP ladder is different than what is indicated in the data sheet.	Х		
	Internal VLCD3 Measurement	3.2	Nonstable readings.	Х		
Liquid Crystal Display (LCD) Controller	LCD Charge Pump Low-Power mode	3.3	The LCD Charge Pump Low-Power (Low-Current (LC)) mode is calibrated but not tested.	Х		
	1/2 MUX, 1/2 Bias with External Resistor Ladder	3.4	1/2 MUX, 1/2 Bias with External Resistor Ladder is not operational.	Х		
Windowed Watchdog Timer (WWDT)	Watchdog Timer Clock Source	4.1	WWDT only operates from the LFINTOSC clock source.			
Comparator (CMP)	C2 Low-Power Clocked Comparator	5.1	Unstable output.		Х	Х
Real-Time Clock and Calendar (RTCC)	RTCC Alarm	6.1	An alarm will not occur if the lower nibble of ALRMLSEC <3:0> is configured to 0x0.		Х	Х

TABLE 2: SILICON ISSUE SUMMARY

Module	Feature	Item Number	Summary	Affected Revisions		
		Number	-	<b>A</b> 1	А3	<b>A4</b>
	VBAT current specification.	7.1	Higher typical current.	Х		
	SMBus VIL Level	7.2	The maximum V <sub>I</sub> L level changes when V <sub>DD</sub> is below 4.0V.	X	X	
	Program Flash Memory (PFM) Endurance	7.3	The PFM endurance is lower than specified.	Х		
Electrical	Internal Oscillator Frequency Accuracy	7.4	Internal oscillator frequency accuracy may be higher than specified at temperatures between 0 and 60°C.	Х	Х	Х
Specifications	Fixed Voltage Reference (FVR) Accuracy	7.5	Fixed Voltage Reference (FVR) output tolerance may be higher than specified at temperatures below -20°C.	Х	Х	
	Nonvolatile Memory (NVM) for LF Devices	7.6	Performing a row erase through the NVMREG access may not execute as expected when VDD is lowered from >3.3V down to <2.0V between +25°C and -40°C.	Х	Х	Х
	Min. VDD Specification	7.7	VDD Min. specifications are changed for LF devices only.	Х	Х	Х

#### Silicon Errata Issues

This document summarizes all silicon Note:

errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (A3).

# 1. Module: Analog-to-Digital Converter with Computation (ADC<sup>2</sup>)

# 1.1 ADC<sup>2</sup> Clock Selection

The ADC does not function properly if FRC is selected as its clock source resulting in the MSB being stuck as a '0' or a '1'. This also prohibits using the ADC module in Sleep mode.

#### Work around

None.

#### **Affected Silicon Revisions**

<b>A1</b>	А3	<b>A4</b>			
Χ					

# 1.2 ADC<sup>2</sup> with Fixed Voltage Reference (FVR)

Using the FVR as the positive voltage reference (VREF+) for the ADC, can cause an increase in missing codes.

#### Work around

Method 1: Increase the bit conversion time, known as TAD, to 8 µs or higher.

Method 2: Use VDD as the positive voltage reference to the ADC.

#### **Affected Silicon Revisions**

<b>A</b> 1	А3	<b>A4</b>			
Χ					

# 1.3 ADC<sup>2</sup> FRC Clock Sleep Mode

If the part is in Sleep and the ADCRC oscillator is used as the clock source to the ADC, the oscillator continues to run after the conversion is complete. This will increase the current consumption in Sleep mode. The oscillator will stop after the device exits Sleep mode and resumes normal code execution.

#### Work around

None.

### Affected Silicon Revisions

<b>A</b> 1	А3	<b>A</b> 4			
Χ					

# 1.4 ADC<sup>2</sup> FRC Clock ADGO Delay

When using the FRC as the clock source for ADC<sup>2</sup>, there is a delay of one instruction cycle between the user setting the ADGO bit and being able to read it. This can lead to a false conversion complete scenario (i.e., ADGO being cleared), depending if the user code has a bit clear test (BTFSC) instruction on the ADGO bit, immediately after setting the ADGO bit. See Code Example below.

BSF	ADCON0, ADGO	;Start conversion
BTFSC	ADCON0, ADGO	; Is conversion done?
GOTO	\$-1	;No, test again

The BTFSC will pass the very first time in this situation.

#### Work around

Add a NOP instruction after setting the ADGO bit and before testing the bit for completion of conversion. See Code Example below:

BSF	ADCON0, ADGO	;Start conversion
NOP		
BTFSC	ADCON0, ADGO	;Is conversion done?
GOTO	\$-1	;No, test again

<b>A</b> 1	А3	A4			
Χ					

# 1.5 ADC<sup>2</sup> Channel Switching

When switching to the FVR Input channel on the ADC or ADC<sup>2</sup>, from a channel that is of a higher voltage than the FVR, certain PMOS gates will turn on and feed current back into other networks that are also supported by the FVR reference voltage. Until the sample and hold capacitor of the ADC discharges to the new lower voltage level, the PMOS circuits will remain on and the circuits supported by the FVR will experience problems. Some of the affects include; the BOR will trigger at a higher voltage, the internal oscillators will experience frequency changes, and the FVR input to the comparator circuit will be a higher than expected voltage.

#### Work around

None.

#### **Affected Silicon Revisions**

<b>A</b> 1	А3	<b>A4</b>			
Χ	Χ				

#### 1.6 ADC<sup>2</sup> Conversion

At the very beginning of the ADC conversion, the input signal may briefly be pulled to ground, which in turn may take some charge out of the internal sample and hold capacitor. The problem is more pronounced on inputs with an impedance greater than 1  $k\Omega.\,$ 

This issue will be seen when sampling the following internal channel inputs: FVR, DAC, and Temperature Indicator and when sampling external sources on an analog pin, including the CVD.

### Work around

When sampling the internal channel inputs, FVR, DAC, and Temperature Indicator, increase the minimum TAD time to 4  $\mu s$  to increase accuracy.

When sampling an external source through an analog pin, keep the input impedance below 1 kO

When using the ADC as an internal reference for the CVD module, there is no work around.

#### **Affected Silicon Revisions**

<b>A1</b>	А3	A4			
Χ	Χ				

#### 2. Module: Reset and VBAT

#### 2.1 VBAT with ULPBOR

In order to avoid high IBAT currents of 10  $\mu$ A or greater, when utilizing VBAT to provide battery backup the ULPBOR should not be activated. When the part is used in this fashion, VDD should also be either off (0 volts) or >1.5V.

#### Work around

Do not use VBAT along with ULPBOR.

<b>A1</b>	А3	<b>A4</b>			
Χ					

# 3. Module: Liquid Crystal Display (LCD) Controller

#### 3.1 LP Ladder

The resistance of the LP Resistor Ladder is 6.6 M-ohms rather than the 3.3 M-ohms indicated in the data sheet.

#### Work around

None.

#### **Affected Silicon Revisions**

<b>A</b> 1	А3	<b>A</b> 4			
Χ					

#### 3.2 Internal VLCD3 Measurement

The ¼ scale tap point provided on the LP Resistor Ladder for use together with the ADC does not provide stable readings to support monitoring of the LCD pump output level.

#### Work around

Measure the VLCD3 via an external ADC.

#### **Affected Silicon Revisions**

<b>A</b> 1	А3	<b>A4</b>			
Х					

#### 3.3 LCD Charge Pump Low-Power Mode

The LCD Charge Pump Low-Power (Low Current (LC)) mode is calibrated to a nominal value but not tested.

#### Work around

None.

#### Affected Silicon Revisions

<b>A</b> 1	А3	A4			
Х					

# 3.4 1/2 MUX, 1/2 Bias with External Resistor Ladder

The 1/2 MUX, 1/2 bias with External Resistor Ladder mode of operation is non-functional.

#### Work around

For 1/2 MUX, 1/2 Bias mode operation use the internal LP, MP or HP ladder.

#### **Affected Silicon Revisions**

<b>A</b> 1	А3	A4			
Χ					

# 4. Module: Windowed Watchdog Timer (WWDT)

# 4.1 Watchdog Timer Clock Source

When the WDTCS <2:0> bits of the WDTCON1 register are set to either the MFINTOSC (b'001') or the SOSC ('b010') clock source, the WWDT does not operate.

# Work around

Use the LFINTOSC (b'000') as the clock source for the WWDT.

#### **Affected Silicon Revisions**

<b>A</b> 1	А3	<b>A4</b>			
Χ					

#### 5. Module: Comparator (CMP)

#### 5.1 C2 Low-Power Clocked Comparator

The output of the Low-Power Clocked Comparator (CMP2) is unstable and is not recommended for use.

#### Work around

None.

#### **Affected Silicon Revisions**

A1	А3	<b>A4</b>			
Х	Х	Х			

# 6. Module: Real-Time Clock and Calendar (RTCC)

#### 6.1 Real-Time Clock and Calendar (RTCC) Alarm

When using the RTCC alarm function in any mode other than AMASK<3:0> =  $0 \pm 00000$  or AMASK<3:0> =  $0 \pm 00001$ , an alarm will not occur if the lower nibble of the ALRMSEC register, ALRMLSEC <3:0>, is configured to 0x0.

#### Work around

If an alarm is desired when the lower nibble of the SECONDS register = 0x0, configure ALRMLSEC<3:0> = 0xA.

<b>A</b> 1	А3	A4			
Χ	Χ	Χ			

#### 7. Module: Electrical Specifications

# 7.1. VBAT Current Specification

IBAT with VBAT, SOSC and RTCC active (VBAT > VDD) is higher than the 400 nA typical target shown on the data sheet. The typical current observed on rev A1 parts at 25°C will be  $1.3~\mu A$  at 3.0V~VDD.

#### Work around

None.

#### **Affected Silicon Revisions**

A1	А3	<b>A4</b>			
Χ					

#### 7.2 SMBus VIL Level

When the VDD voltage level supplied to the device is 4.0V and above, the maximum SMBus voltage level for the VIL parameter is 0.8V. When VDD drops below 4.0V, the maximum SMBus voltage level for VIL drops to 0.7V.

#### Work around

None.

#### **Affected Silicon Revisions**

<b>A1</b>	А3	<b>A4</b>			
Χ	Χ				

#### 7.3 Program Flash Memory Endurance

The minimum value for the Program Flash Memory (PFM) endurance specification, called out as parameter number MEM30 in the data sheet, is 1K cycles.

# Work around

None.

#### **Affected Silicon Revisions**

<b>A1</b>	А3	A4			
Χ					

#### 7.4 Internal Oscillator Frequency Accuracy

HFINTOSC frequency accuracy is greater than shown on the data sheet in Figure 39-6 and listed in Note 1 of the same figure. Over the temperature range of 0 to 60°C, and over VDD range of 2.3V to 5.5V, the internal oscillator frequency accuracy has changed from +/-2% to +/-3%.

#### Work around

None.

# **Affected Silicon Revisions**

<b>A</b> 1	А3	<b>A</b> 4			
Х	Χ	Х			

#### 7.5 Fixed Voltage Reference (FVR) Accuracy

At temperatures below -20°C, the output voltage for the FVR may be greater than the levels specified in the data sheet. This will apply to all three gain amplifier settings (1X, 2X, 4X). The affected parameter numbers found in the data sheet are: FVR01 (1X gain setting), FVR02 (2X gain setting), and FVR03 (4X gain setting).

#### Work around

At temperatures above -20°C, the stated tolerances in the data sheet remain in effect. Operate the FVR only at temperatures above - 20°C.

#### **Affected Silicon Revisions**

<b>A</b> 1	А3	<b>A4</b>			
Χ	Χ				

#### 7.6 Nonvolatile Memory (NVM) for LF Devices

Performing a row erase through the NVMREG access on LF device may not execute as expected when VDD is lowered from >3.3V down to <2.0V before or during the row erase while also operating between +25°C and -40°C.

#### Work around

None.

#### **Affected Silicon Revisions**

<b>A</b> 1	А3	<b>A4</b>			
Χ	Χ	Χ			

#### 7.7 Minimum VDD Specification for LF Devices

VDD minimum parameter (D002) at -40°C to  $25^{\circ}\text{C}$  = 2.3V.

#### Work around

None.

<b>A</b> 1	А3	<b>A</b> 4			
Χ	Χ	Χ			

#### **Data Sheet Clarifications**

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS40001873**E**):

**Note:** Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

#### 1. Module: I/O Ports

**1.1** Weak pull-up functionality is not available on pin RA5. The figures below show the data sheet corrections relating to this item.

#### 1.2 Register 14-5 WPUA: WEAK PULL-UP PORTA REGISTER

R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
WPUA7	WPUA6	_	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0
bit 7	•	•	•	•	•	•	bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 WPUA<7:6>: Weak Pull-up Register bits<sup>(1)</sup>

For RA<7:6> pins, respectively

1 = Pull-up enabled 0 = Pull-up disabled

bit 5 Unimplemented: Read as '0'

bit 4-0 WPUA<4:0>: Weak Pull-up Register bits<sup>(1)</sup>

For RA<4:0> pins, respectively

1 = Pull-up enabled 0 = Pull-up disabled

Note 1: The weak pull-up device is automatically disabled if the pin is configured as an output.

#### 1.3 Table 14-2: SUMMARY OF REGISTER ASSOCIATED WITH PORTA

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
PORTA	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0	205
TRISA	TRISA7	TRISA6	(1)	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	205
LATA	LATA7	LATA6	_	LATA4	LATA3	LATA2	LATA1	LATA0	206
ANSELA	ANSA7	ANSA6	_	ANSA4	ANSA3	ANSA2	ANSA1	ANSA0	206
WPUA	WPUA7	WPUA6	_	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	207
ODCONA	ODCA7	ODCA6	_	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0	207
SLRCONA	SLRA7	SLRA6	_	SLRA4	SLRA3	SLRA2	SLRA1	SLRA0	208
INLVLA	INLVLA7	INLVLA6	INLVLA5	INLVLA4	INLVLA3	INLVLA2	INLVLA1	INLVLA0	208

**Legend:** x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTA.

Note 1: Unimplemented, read as '1'.

# 1.4 Table 4-12: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 PIC(L)F19195/6/7

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
1F37h	RE7PPS	1	1	1	RE7PPS4	RE7PPS3	RE7PPS2	RE7PPS1	RE7PPS0	0 0000	u uuuu
1F38h	ANSELA	ANSA7	ANSA6	_	ANSA4	ANSA3	ANSA2	ANSA1	ANSA0	11-1 1111	11-1 1111
1F39h	WPUA	WPUA7	WPUA6	_	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	0000 0000	0000 0000
1F3Ah	ODCONA	ODCA7	ODCA6	_	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0	00-0 0000	00-0 0000
1F3Bh	SLRCONA	SLRA7	SLRA6	ı	SLRA4	SLRA3	SLRA2	SLRA1	SLRA0	11-1 1111	11-1 1111
1F3Ch	INLVLA	INLVLA7	INLVLA6	INLVLA5	INLVLA4	INLVLA3	INLVLA2	INLVLA1	INLVLA0	1111 1111	1111 1111
1F3Dh	IOCAP	IOCAP7	IOCAP6	IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0	0000 0000	0000 0000
1F3Eh	IOCAN	IOCAN7	IOCAN6	IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0	0000 0000	0000 0000
1F3Fh	IOCAF	IOCAF7	IOCAF6	IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0	0000 0000	0000 0000

# 1.5 Table 38-1: REGISTER FILE SUMMARY FOR PIC(L)F19195/6/7 DEVICES

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
1F33h	RE3PPS	-	_	_	RE3PPS4	RE3PPS3	RE3PPS2	RE3PPS1	RE3PPS0	260
1F34h	RE4PPS		1	_	RE4PPS4	RE4PPS3	RE4PPS2	RE4PPS1	RE4PPS0	260
1F35h	RE5PPS	1	1	-	RE5PPS4	RE5PPS3	RE5PPS2	RE5PPS1	RE5PPS0	260
1F36h	RE6PPS	1	1	-	RE6PPS4	RE6PPS3	RE6PPS2	RE6PPS1	RE6PPS0	260
1F37h	RE7PPS	1	1	_	RE7PPS4	RE7PPS3	RE7PPS2	RE7PPS1	RE7PPS0	260
1F38h	ANSELA	ANSA7	ANSA6	_	ANSA4	ANSA3	ANSA2	ANSA1	ANSA0	206
1F39h	WPUA	WPUA7	WPUA6	-	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	207
1F3Ah	ODCONA	ODCA7	ODCA6	_	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0	207
1F3Bh	SLRCONA	SLRA7	SLRA6	_	SLRA4	SLRA3	SLRA2	SLRA1	SLRA0	208
1F3Ch	INLVLA	INLVLA7	INLVLA6	INLVLA5	INLVLA4	INLVLA3	INLVLA2	INLVLA1	INLVLA0	208
1F3Dh	IOCAP	IOCAP7	IOCAP6	IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0	_
1F3Eh	IOCAN	IOCAN7	IOCAN6	IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0	_
1F3Fh	IOCAF	IOCAF7	IOCAF6	IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0	_

# APPENDIX A: DOCUMENT REVISION HISTORY

# **Rev J Document (06/2022)**

Added Data Sheet Clarification 1 (I/O Ports) for data sheet revision E. Included Register 14-5, Table 14-2, Table 4-12, and Table 38-1 with pin RA5 removed in reference to WPUA5.

# Rev H Document (09/2021)

Removed Data Sheet Clarification section and its subsection (Data Sheet updated).

# Rev G Document (02/2021)

Updated Table 2 and sub-section 7.7. Added DS Clarifications: Module 1: Electrical Specifications. Minor editorial corrections.

# Rev F Document (06/2019)

Removed Module 7.8 Program Flash Memory (PFM) Endurance (redundant).

Data Sheet Clarifications: Removed all modules (Data Sheet updated).

# Rev E Document (08/2018)

Added A4 silicon rev. Added Module 1.3 ADC<sup>2</sup> FRC Clock Sleep Mode. Added Module 1.4 ADC<sup>2</sup> FRC Clock ADGO Delay. Added Module 1.5 ADC<sup>2</sup> Channel Switching. Added Module 1.6 ADC<sup>2</sup> Conversion. Added Module 6: Real Time Clock and Calendar (RTCC) and 6.1 RTCC Alarm. Added Module 7.8 Program Flash Memory (PFM) Endurance. Updated Table 2.

# **Rev D Document (05/2018)**

Data Sheet Clarifications: Added Module 1: Analog-to-Digital with Computation (ADC<sup>2</sup>) and Module 2: Real Time Clock and Calendar (RTCC). Added Module 7.8 Program Flash Memory (PFM) Endurance.

### Rev C Document (01/2018)

Added Module 6.7: Min. VDD Specifications. Updated Modules 6.3, 6.4, and 6.5 "Affected Silicon Revisions" Tables.

#### **Rev B Document (10/2017)**

Removed Module 6.1: ADC Offset and Gain Error; Added Module 6.4: Internal Oscillator Frequency Accuracy; Added Module 6.6: Nonvolatile Memory (NVM) for LF Devices; Added affected revision A3; Other minor corrections.

Data Sheet Clarifications: Removed Module 1 (Data Sheet updated).

### **Rev A Document (03/2017)**

Initial release of this document; issued for revision A1. Includes silicon issues 1.1 (ADC<sup>2</sup>), 1.2 (ADC<sup>2</sup>), 2.1 (VBAT), 3.1 (LCD), 3.2 (LCD), 3.3 (LCD), 3.4 (LCD), 4.1 (WWDT), 5.1 (CMP),

Electrical Specifications: 6.1 ADC, 6.2 VBAT, 6.3 SMBus, 6.4 Program Flash Memory, and 6.5 FVR.

Data Sheet Clarifications: Module 1: LCD

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